

Is Now Part of



ON Semiconductor®

To learn more about ON Semiconductor, please visit our website at www.onsemi.com

ON Semiconductor and the ON Semiconductor logo are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any EDA Class 3 medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officers, employees, emplo



March 2015

FDS8672S

N-Channel PowerTrench[®] SyncFETTM 30V, 18A, 4.8m Ω

Features

- Max $r_{DS(on)} = 4.8m\Omega$ at $V_{GS} = 10V$, $I_D = 18A$
- Max $r_{DS(on)} = 7.0 \text{m}\Omega$ at $V_{GS} = 4.5 \text{V}$, $I_D = 15 \text{A}$
- Includes SyncFET Schottky Body Diode
- High Performance Trench Technology for Extremely Low r_{DS(on)} and Fast Switching
- High Power and Current Handling Capability
- 100% R_a (Gate Resistance) Tested
- Termination is Lead-free and RoHS Compliant

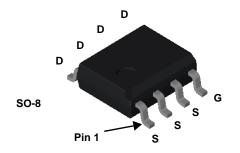


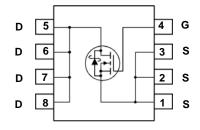
General Description

The FDS8672S is designed to replace a single MOSFET and Schottky diode in synchronous DC/DC power supplies. This 30V MOSFET is designed to maximize power conversion efficiency, providing a low $\rm r_{DS(on)}$ and low gate charge. The FDS8672S includes a patented combination of a MOSFET monolithically integrated with a Schottky diode using Fairchild's monolithic SyncFET technology.

Applications

- Synchronous Rectifier for DC/DC Converters
- Notebook Vcore Low Side Switch
- Point of Load Low Side Switch





MOSFET Maximum Ratings T_A = 25°C unless otherwise noted.

Symbol	Parai	meter		Ratings	Units
V _{DS}	Drain to Source Voltage			30	V
V_{GS}	Gate to Source Voltage			±20	V
	Drain Current -Continuous			18	۸
'D	-Pulsed		(Note 4)	80	A
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	216	mJ
В	Power Dissipation	T _A = 25°C	(Note 1a)	2.5	W
P_{D}	Power Dissipation	T _A = 25°C	(Note 1b)	1.0	VV
T _J , T _{STG}	Operating and Storage Junction Tempe	erature Range		-55 to +150	°C

Thermal Characteristics

$R_{\theta JC}$	Thermal Resistance, Junction to Case	(Note 1)	25	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	(Note 1a)	50	C/VV

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDS8672S	FDS8672S	SO8	13"	12mm	2500 units

Electrical Characteristics $T_J = 25$ °C unless otherwise noted.

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
Off Chara	acteristics					
BV _{DSS}	Drain to Source Breakdown Voltage	$I_D = 1 \text{mA}, V_{GS} = 0 \text{V}$	30			V
$\frac{\Delta BV_{DSS}}{\Delta T_{J}}$	Breakdown Voltage Temperature Coefficient	I _D = 10mA, referenced to 25°C		33		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 24V, V _{GS} = 0V			500	μΑ
I _{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20V, V_{DS} = 0V$			±100	nA

On Characteristics

$V_{GS(th)}$	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 1mA$	1.0	2.1	3.0	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	I _D = 10mA, referenced to 25°C		-5		mV/°C
	Static Drain to Source On Resistance	$V_{GS} = 10V, I_D = 18A$		3.8	4.8	
r _{DS(on)}		$V_{GS} = 4.5V, I_D = 15A$		5.3	7.0	mΩ
		$V_{GS} = 10V$, $I_D = 18A$, $T_J = 125$ °C		5.3	7.8	
9 _{FS}	Forward Transconductance	$V_{DS} = 5V, I_{D} = 18A$		78		S

Dynamic Characteristics

C _{iss}	Input Capacitance	\\ 45\\\\\ 0\\	2005	2670	pF
C _{oss}	Output Capacitance	$V_{DS} = 15V, V_{GS} = 0V,$ f = 1MHz	985	1310	рF
C _{rss}	Reverse Transfer Capacitance	1 - 1101112	135	205	pF
R_{α}	Gate Resistance	f = 1MHz	0.6	2.0	Ω

Switching Characteristics

t _{d(on)}	Turn-On Delay Time			12	22	ns
t _r	Rise Time	$V_{DD} = 15V, I_{D} = 18A,$ $V_{GS} = 10V, R_{GEN} = 6\Omega$		4	10	ns
t _{d(off)}	Turn-Off Delay Time	$V_{GS} = 10V, R_{GEN} = 002$		26	42	ns
t _f	Fall Time			3	10	ns
Q_g	Total Gate Charge	V _{GS} = 0V to 10V		29	41	nC
Qg	Total Gate Charge	$V_{GS} = 0V \text{ to } 5V$ $V_{DD} = 15$	oV,	15	21	nC
Q _{gs}	Gate to Source Charge	1 _D = 10 <i>P</i>	`	5.5		nC
Q _{gd}	Gate to Drain "Miller" Charge			3.7		nC

Drain-Source Diode Characteristics

V	Source to Drain Diode Forward Voltage	$V_{GS} = 0V, I_{S} = 18A$	0.8	1.2	V
V _{SD}	Source to Drain blode Forward voltage	$V_{GS} = 0V, I_{S} = 1.8A$	0.4	0.7	V
t _{rr}	Reverse Recovery Time	- I _F = 18A, di/dt = 300A/μs	27	43	ns
Q _{rr}	Reverse Recovery Charge	$I_F = 16A$, $di/dt = 300A/\mu$ S	31	50	nC
NOTES:					

^{1.} R_{0LA} is determined with the device mounted on a 1in² pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. R_{0LC} is guaranteed by design while R_{0CA} is determined by the user's board design.



a) 50°C/W when mounted on a 1in² pad of 2 oz copper.



b) 125°C/W when mounted on a minimum pad.

^{2.} Pulse Test: Pulse Width < 300 μ s, Duty cycle < 2.0%. 3. Starting T $_J$ = 25°C, L = 3mH, I $_{AS}$ = 12A, V $_{DD}$ = 30V, V $_{GS}$ = 10V. 4. Pulse current was measured at 250uS pulse, refer to Fig 11 Forward Safe Operation Area for detail.

Typical Characteristics T_J = 25°C unless otherwise noted.

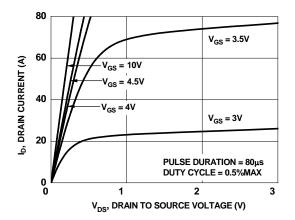


Figure 1. On-Region Characteristics

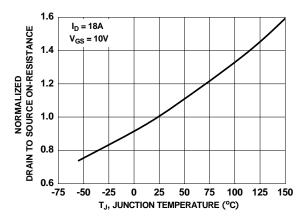


Figure 3. Normalized On-Resistance vs. Junction Temperature

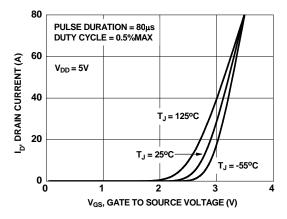


Figure 5. Transfer Characteristics

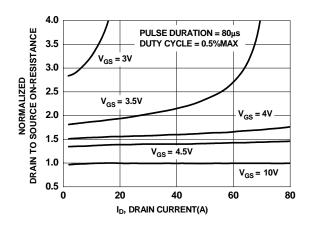


Figure 2. Normalized On-Resistance vs. Drain Current and Gate Voltage

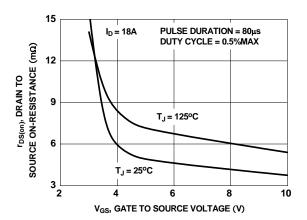


Figure 4. On-Resistance vs. Gate to Source Voltage

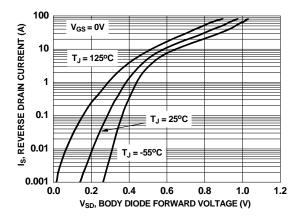


Figure 6. Source to Drain Diode Forward Voltage vs. Source Current

Typical Characteristics $T_J = 25$ °C unless otherwise noted.

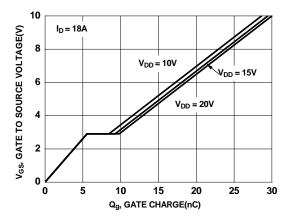


Figure 7. Gate Charge Characteristics

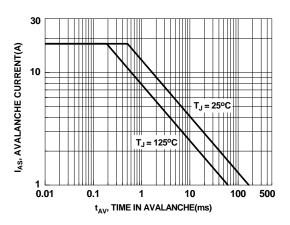


Figure 9. Unclamped Inductive Switching Capability

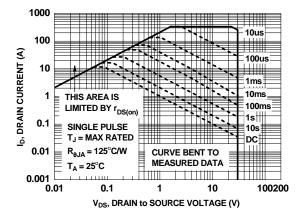


Figure 11. Forward Bias Safe Operating Area

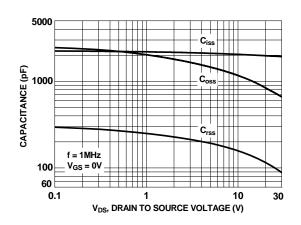


Figure 8. Capacitance vs. Drain to Source Voltage

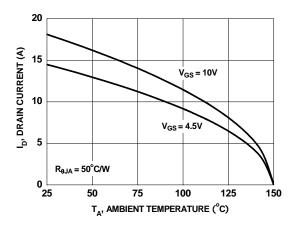


Figure 10. Maximum Continuous Drain Current vs. Ambient Temperature

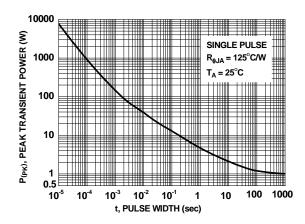


Figure 12. Single Pulse Maximum Power Dissipation

Typical Characteristics T_J = 25°C unless otherwise noted.

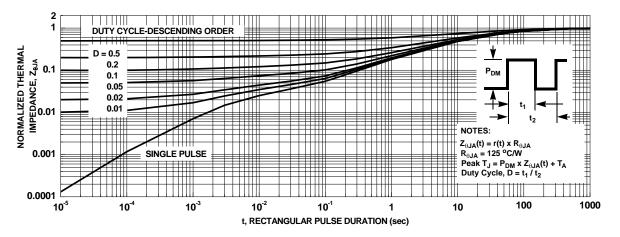
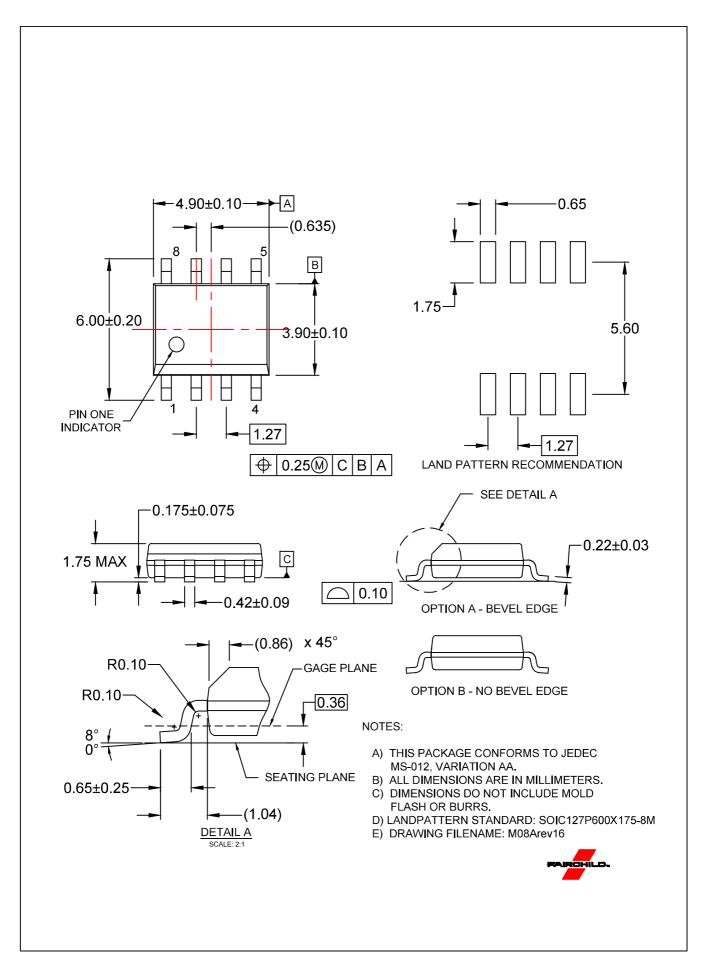


Figure 13. Junction-to-Ambient Transient Thermal Response Curve



ON Semiconductor and in are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdt/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and exp

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor 19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com N. American Technical Support: 800–282–9855 Toll Free USA/Canada
Europe, Middle East and Africa Technical Support: Phone: 421 33 790 2910
Japan Customer Focus Center
Phone: 81–3–5817–1050

ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative